

## HIGH VOLTAGE $I_o = 500 \text{ mA}$ LDO REGULATOR

### ■ FEATURES

- AEC-Q100 grade 1 qualified
- Fast transient response
- Wide operating voltage       $4.0 \text{ V to } 40 \text{ V}$
- Wide operating temperature       $T_a = -40^\circ\text{C to } 125^\circ\text{C}$
- High-accuracy output voltage       $V_o \pm 1.0\% \text{ (} T_a = 25^\circ\text{C) }$
- Output current       $V_o \pm 1.5\% \text{ (} T_a = -40^\circ\text{C to } 125^\circ\text{C) }$
- ON/OFF control
- Ceramic capacitor compatible
- Undervoltage lockout
- Thermal shutdown
- Overcurrent protection
- Package      TO-252-5-L5

### ■ APPLICATIONS\*

- Car infotainment
- Automotive ECUs
- Industrial equipment

\*T1 grade is not recommended for powertrain, vehicle electrification and autonomous driving related applications.

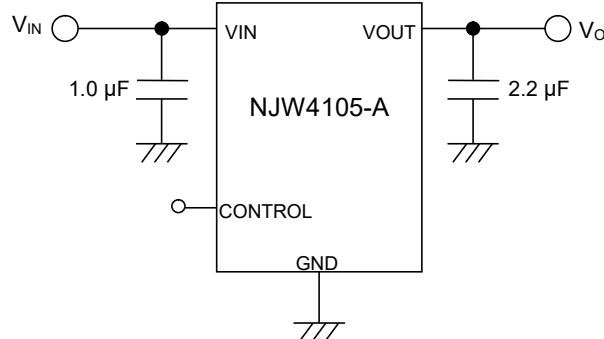
### ■ DESCRIPTION

The NJW4105-T1 is a 45 V,  $I_o = 500 \text{ mA}$  fast transient response low dropout regulator. This device achieves fast transient response and offers stable output voltage at line or load fluctuations.

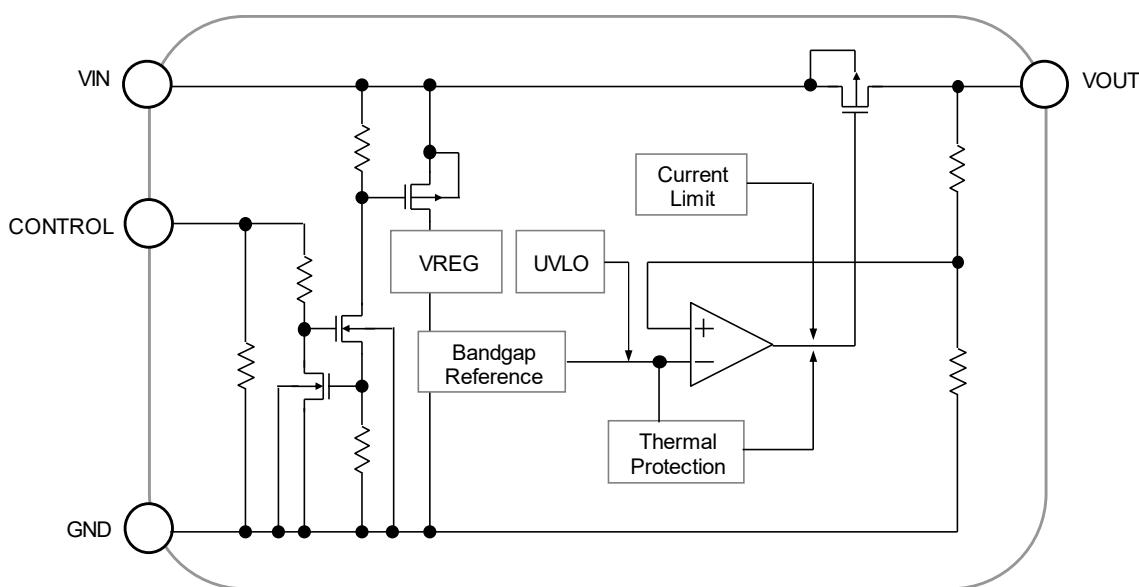
The NJW4105-T1 provides outstanding high output voltage accuracy that guaranteed  $\pm 1.5\%$  under the conditions of  $V_{IN} = V_o + 1 \text{ V to } 40 \text{ V}$ ,  $I_o = 0 \text{ mA to } 500 \text{ mA}$ , and  $T_a = -40^\circ\text{C to } 125^\circ\text{C}$ .

Moreover, wide operating voltage and wide operating temperature make the NJW4105-T1 ideal for automotive equipment or applications that require high reliability.

### ■ TYPICAL APPLICATION



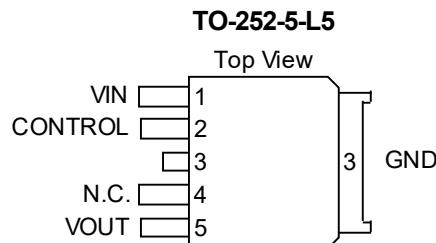
### ■ BLOCK DIAGRAM



### ■ OUTPUT VOLTAGE RANK

PRODUCT NAME	OUTPUT VOLTAGE
NJW4105DL5-33A-T1	3.3 V
NJW4105DL5-05A-T1	5.0 V
NJW4105DL5-08A-T1	8.0 V

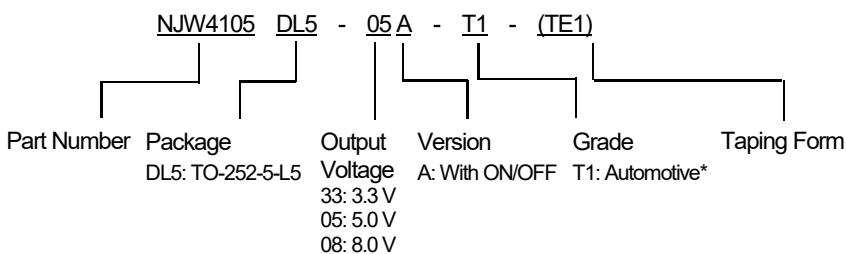
### ■ PIN CONFIGURATION



PIN NO.	NAME	FUNCTION
1	VIN	Input pin
2	CONTROL	ON/OFF control pin
3	GND	Ground pin
4	N.C.	Not internally connected*
5	VOUT	Output pin

\*This pin is not internally connected. Connect to ground or leave floating (open). Connect to ground to improve heat dissipation.

### ■ PRODUCT NAME INFORMATION



\* The detail information of automotive grades and recommended applications are described in NJR website.  
[https://www.njr.com/electronic\\_device/semiconductor/application/automotive.html.](https://www.njr.com/electronic_device/semiconductor/application/automotive.html.)

### ■ ORDERING INFORMATION

PRODUCT NAME	PACKAGE	RoHS	HALOGEN-FREE	TERMINAL FINISH	MARKING	WEIGHT (mg)	MOQ (pcs)
NJW4105DL5-33A-T1 (TE1)	TO-252-5-L5	Yes	Yes	Sn-2Bi	105A33T1	301	3000
NJW4105DL5-05A-T1 (TE1)	TO-252-5-L5	Yes	Yes	Sn-2Bi	105A05T1	301	3000
NJW4105DL5-08A-T1 (TE1)	TO-252-5-L5	Yes	Yes	Sn-2Bi	105A08T1	301	3000

**■ ABSOLUTE MAXIMUM RATINGS**

PARAMETER	SYMBOL	RATING	UNIT
Input Voltage	$V_{IN}$	-0.3 to 45	V
Control Voltage	$V_{CONT}$	-0.3 to 45	V
Output Voltage	$V_o$	-0.3 to $V_{IN} \leq +17^{(1)}$	V
Power Dissipation ( $T_a = 25^\circ C$ ) TO-252-5-L5	$P_D$	2-Layer / 4-Layer / High Power 4-Layer 870 <sup>(2)</sup> / 3000 <sup>(3)</sup> / 4700 <sup>(4)</sup>	mW
Junction Temperature	$T_j$	-40 to 150	°C
Storage Temperature	$T_{stg}$	-50 to 150	°C

(1) When the input voltage is less than 17 V, the absolute maximum output voltage is equal to the input voltage. If the input voltage is below 17 V, the maximum output voltage is 17 V.

(2) 2-Layer: Mounted on glass epoxy board (76.2 mm × 114.3 mm × 1.6 mm: based on EIA/JEDEC standard, 2-layer FR-4).

(3) 4-Layer: Mounted on glass epoxy board (76.2 mm × 114.3 mm × 1.6 mm: based on EIA/JEDEC standard, 4-layer FR-4).

(For 4-layer: Applying 74.2 mm × 74.2 mm inner Cu area and a thermal via hole to a board based on JEDEC standard JESD51-5.)

(4) High Power 4-Layer: Mounted on glass epoxy board (76.2 mm × 114.3 mm × 1.6 mm, 4-layer FR-4).

(For 4-layer: Applying 74.2 mm × 74.2 mm inner Cu area and a thermal via hole to a board based on JEDEC standard JESD51-5.)

\*For the specifications of each board, see the Board Specifications of THERMAL CHARACTERISTICS.

**■ RECOMMENDED OPERATING CONDITIONS**

PARAMETER	SYMBOL	VALUE	UNIT
Operating Voltage	$V_{IN}$	4.0 to 40	V
Control Voltage	$V_{CONT}$	0 to 40	V
Output Current	$I_o$	0 to 500	mA
Operating Temperature	$T_{opr}$	-40 to 125	°C

## ■ ELECTRICAL CHARACTERISTICS

 $V_{IN} = V_O + 1 \text{ V}$ ,  $C_{IN} = 1.0 \mu\text{F}$ ,  $C_O = 2.2 \mu\text{F}$ ,  $T_a = 25^\circ\text{C}$ , unless otherwise noted.

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
Output Voltage	$V_O$	$V_{IN} = V_O + 1 \text{ V}$ to 40 V, $I_O = 0 \text{ mA}$ to 500 mA	-1.0%	-	+1.0%	V
		$V_{IN} = V_O + 1 \text{ V}$ to 40 V, $I_O = 0 \text{ mA}$ to 500 mA $T_a = -40^\circ\text{C}$ to 125°C	-1.5%	-	+1.5%	
Quiescent Current	$I_Q$	$I_O = 0 \text{ mA}$ , except $I_{CONT}$	-	65	105	$\mu\text{A}$
		$I_O = 0 \text{ mA}$ , except $I_{CONT}$ , $T_a = -40^\circ\text{C}$ to 125°C	-	-	115	
Quiescent Current at Control OFF	$I_Q(\text{OFF})$	$V_{CONT} = 0 \text{ V}$	-	-	1	$\mu\text{A}$
		$V_{CONT} = 0 \text{ V}$ , $T_a = -40^\circ\text{C}$ to 125°C	-	-	1	
Output Current	$I_O$	$V_O \times 0.9$	500	-	-	mA
		$V_O \times 0.9$ , $T_a = -40^\circ\text{C}$ to 125°C	500	-	-	
Line Regulation	$\Delta V_O / \Delta V_{IN}$	$V_{IN} = V_O + 1 \text{ V}$ to 40 V, $I_O = 30 \text{ mA}$	$V_O = 3.3 \text{ V}$	-	-	23.5
			$V_O = 5.0 \text{ V}$	-	-	34.0
			$V_O = 8.0 \text{ V}$	-	-	52.5
		$V_{IN} = V_O + 1 \text{ V}$ to 40 V, $I_O = 30 \text{ mA}$ $T_a = -40^\circ\text{C}$ to 125°C	$V_O = 3.3 \text{ V}$	-	-	35.3
			$V_O = 5.0 \text{ V}$	-	-	51.0
			$V_O = 8.0 \text{ V}$	-	-	81.6
		$I_O = 0 \text{ mA}$ to 500 mA	$V_O = 3.3 \text{ V}$	-	-	18.5
			$V_O = 5.0 \text{ V}$	-	-	22.5
			$V_O = 8.0 \text{ V}$	-	-	36.0
		$I_O = 0 \text{ mA}$ to 500 mA, $T_a = -40^\circ\text{C}$ to 125°C	$V_O = 3.3 \text{ V}$	-	-	29.7
			$V_O = 5.0 \text{ V}$	-	-	45.0
			$V_O = 8.0 \text{ V}$	-	-	72.0
Ripple Rejection	RR	$V_{IN} = V_O + 1 \text{ V}$ , $e_{IN} = 200 \text{ mVrms}$ , $f = 1 \text{ kHz}$ , $I_O = 10 \text{ mA}$	$V_O = 3.3 \text{ V}$	-	56	-
			$V_O = 5.0 \text{ V}$	-	53	-
			$V_O = 8.0 \text{ V}$	-	50	-
Dropout Voltage 1 <sup>(5)</sup>	$\Delta V_{IO1}$	$I_O = 300 \text{ mA}$	-	0.24	0.42	V
		$I_O = 300 \text{ mA}$ , $T_a = -40^\circ\text{C}$ to 125°C	-	-	0.60	
Dropout Voltage 2 <sup>(5)</sup>	$\Delta V_{IO2}$	$I_O = 500 \text{ mA}$	-	0.40	0.70	V
		$I_O = 500 \text{ mA}$ , $T_a = -40^\circ\text{C}$ to 125°C	-	-	1.00	
Control Current	$I_{CONT}$	$V_{CONT} = 1.6 \text{ V}$	-	0.5	2.0	$\mu\text{A}$
		$V_{CONT} = 1.8 \text{ V}$ , $T_a = -40^\circ\text{C}$ to 125°C	-	-	3.0	
Control Voltage for ON-State	$V_{CONT(ON)}$		1.6	-	-	V
		$T_a = -40^\circ\text{C}$ to 125°C	1.8	-	-	
Control Voltage for OFF-State	$V_{CONT(OFF)}$		-	-	0.6	V
		$T_a = -40^\circ\text{C}$ to 125°C	-	-	0.6	
UVLO Release Voltage	$V_{UVLO}$	$V_{IN} = \text{low to high}$	2.3	2.7	3.1	V
		$V_{IN} = \text{low to high}$ , $T_a = -40^\circ\text{C}$ to 125°C	2.2	-	3.2	
UVLO Hysteresis Voltage	$V_{HYS}$	$V_{IN} = \text{high to low}$	200	500	-	mV
		$V_{IN} = \text{high to low}$ , $T_a = -40^\circ\text{C}$ to 125°C	200	-	-	
Average Temperature Coefficient of Output Voltage	$\Delta V_O / \Delta T_a$	$T_a = -40^\circ\text{C}$ to 125°C, $I_O = 30 \text{ mA}$	-	$\pm 50$	-	ppm/ $^\circ\text{C}$

(5) Output voltages below 3.8 V are excluded.

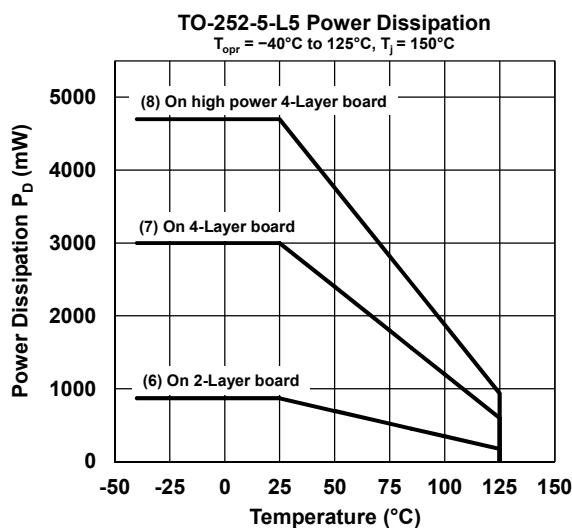
### ■ THERMAL CHARACTERISTICS

PARAMETER	SYMBOL	VALUE	UNIT
Junction-To-Ambient Thermal Resistance TO-252-5-L5	$\theta_{ja}$	2-Layer / 4-Layer / High Power 4-Layer 143 <sup>(6)</sup> / 41 <sup>(7)</sup> / 26 <sup>(8)</sup>	°C/W
Junction-To-Top of Package Characterization Parameter TO-252-5-L5	$\Psi_j$	2-Layer / 4-Layer / High Power 4-Layer 30 <sup>(6)</sup> / 15 <sup>(7)</sup> / 11 <sup>(8)</sup>	°C/W

### ■ BOARD SPECIFICATIONS

BOARD	JEDEC 2-LAYER BOARD	JEDEC 4-LAYER BOARD	HIGH POWER 4-LAYER BOARD
Dimension	76.2 mm × 114.3 mm, t = 1.6 mm		
Material	FR-4		
Cu Area	Surface Layer (Thickness: 70 µm)	NJR recommended land pattern + Measurement wiring	NJR recommended land pattern + Measurement wiring
	2 <sup>nd</sup> Layer (Thickness: 35 µm)	-	74.2 mm × 74.2 mm 74.2 mm × 74.2 mm
	3 <sup>rd</sup> Layer (Thickness: 35 µm)	-	74.2 mm × 74.2 mm 74.2 mm × 74.2 mm
	Back Layer (Thickness: 70 µm)	-	- 74.2 mm × 74.2 mm
	Thermal Vias	-	Connected from surface layer to 2 <sup>nd</sup> layer All layers are connected

### ■ POWER DISSIPATION vs. AMBIENT TEMPERATURE



(6) 2-Layer: Mounted on glass epoxy board (76.2 mm × 114.3 mm × 1.6 mm: based on EIA/JEDEC standard, 2-layer FR-4).

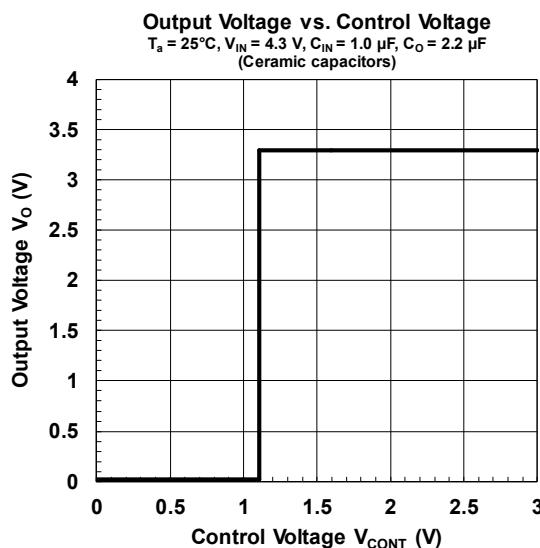
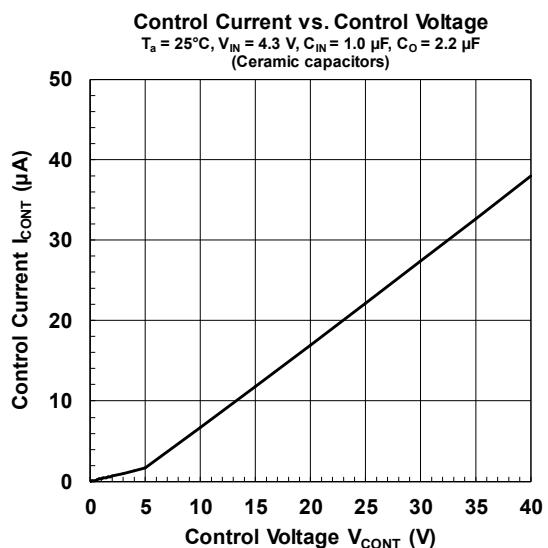
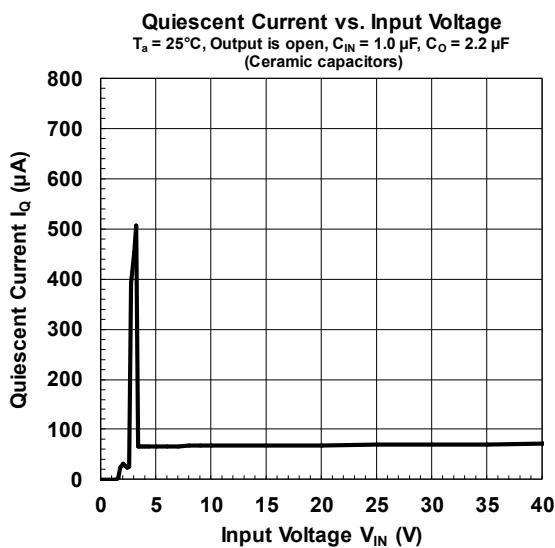
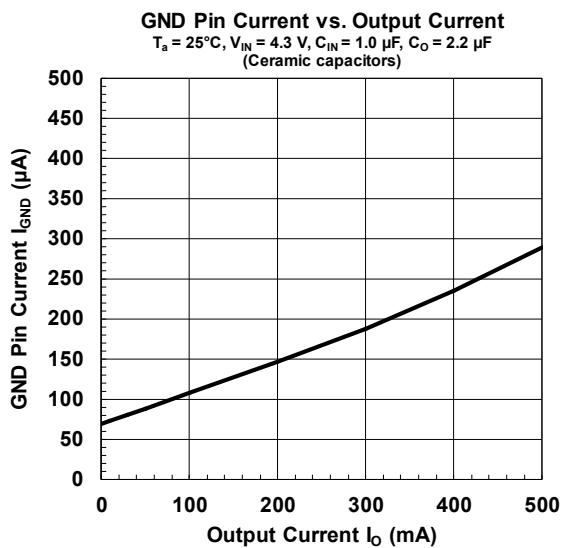
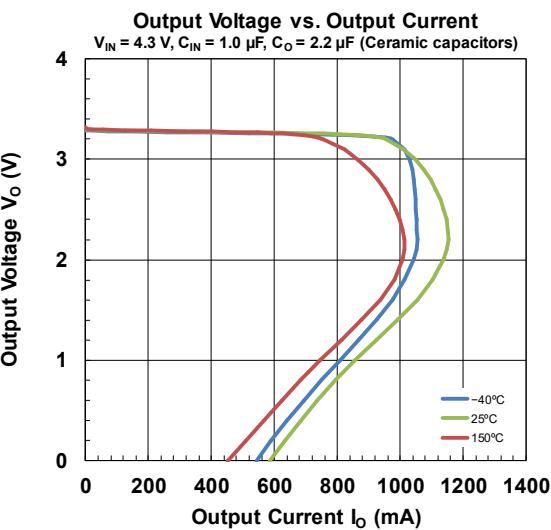
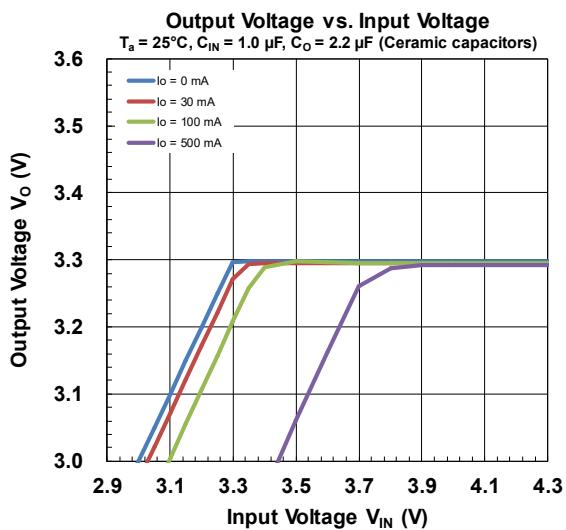
(7) 4-Layer: Mounted on glass epoxy board (76.2 mm × 114.3 mm × 1.6 mm: based on EIA/JEDEC standard, 4-layer FR-4).

(For 4-layer: Applying 74.2 mm × 74.2 mm inner Cu area and a thermal via hole to a board based on JEDEC standard JESD51-5.)

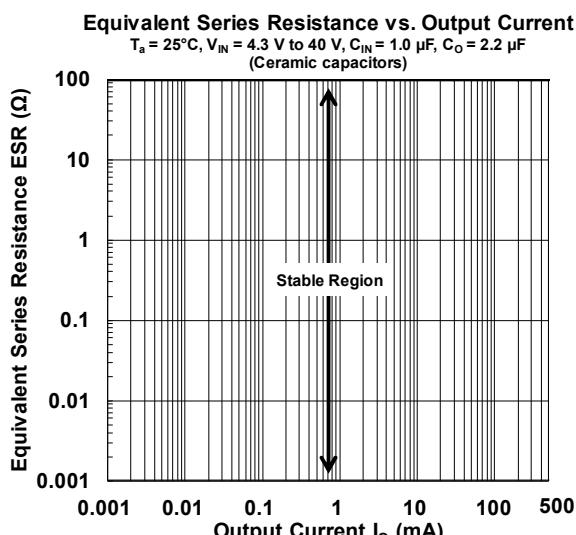
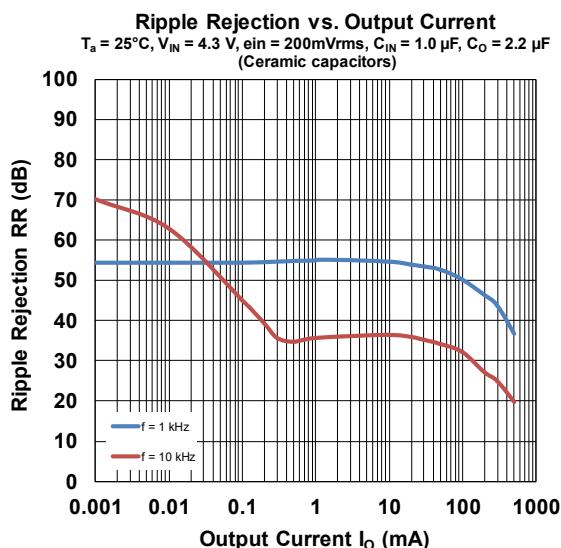
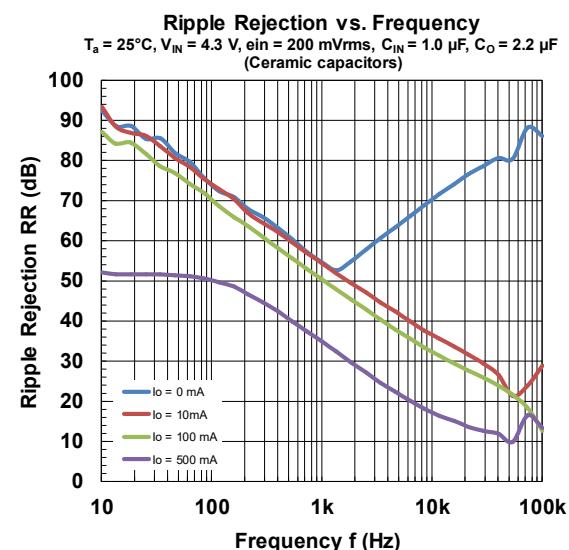
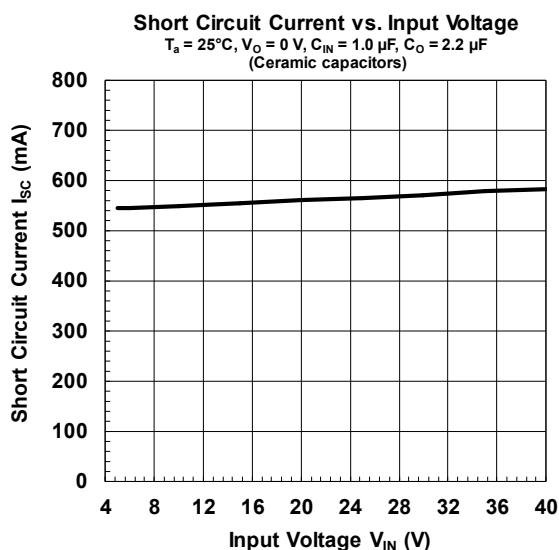
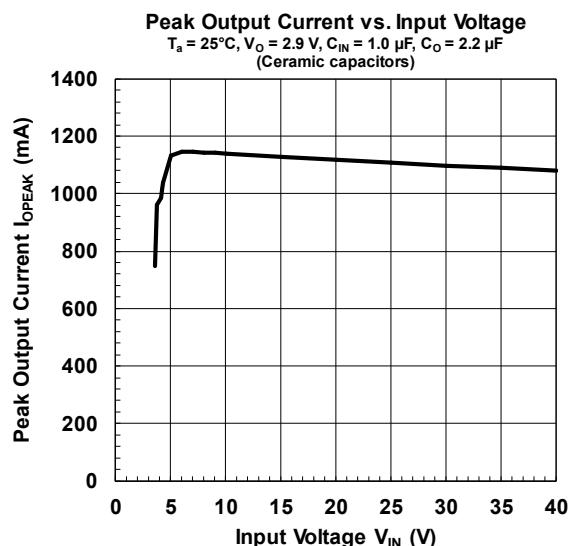
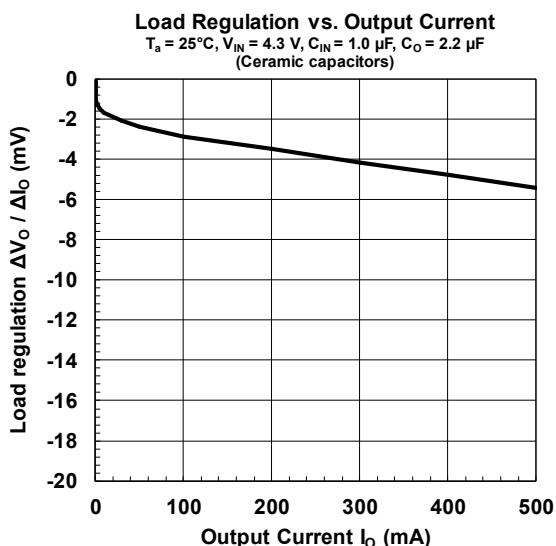
(8) High Power 4-Layer: Mounted on glass epoxy board (76.2 mm × 114.3 mm × 1.6 mm, 4-layer FR-4).

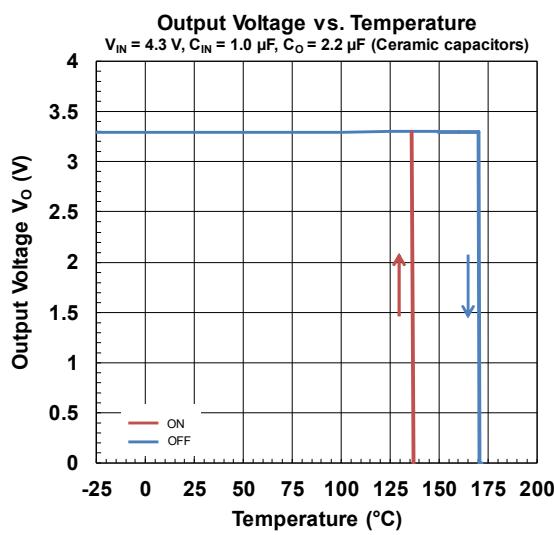
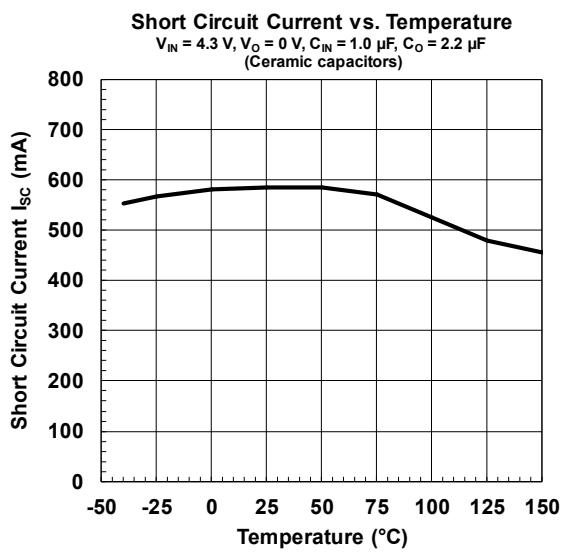
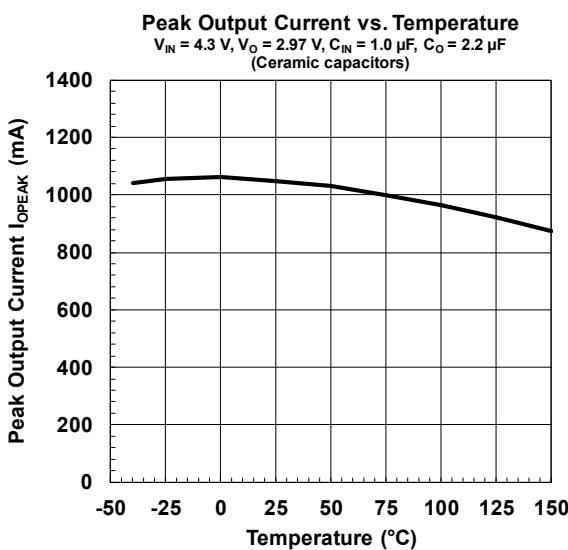
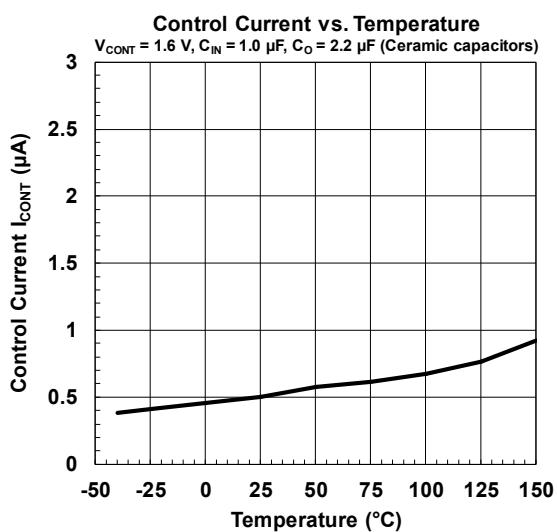
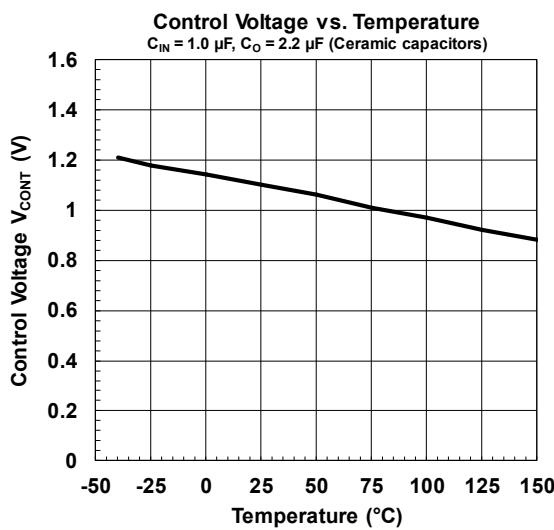
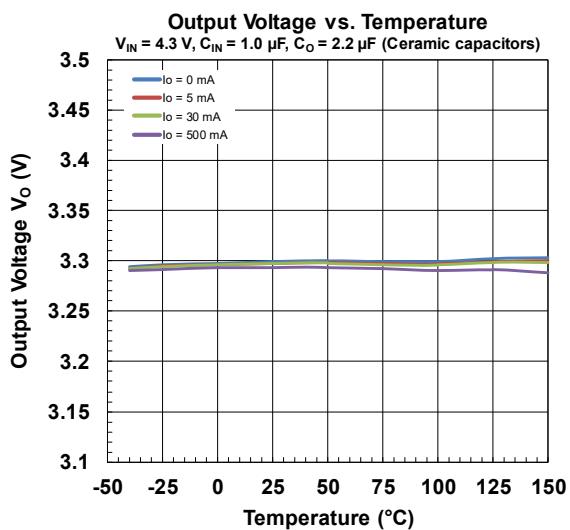
(For 4-layer: Applying 74.2 mm × 74.2 mm inner Cu area and a thermal via hole to a board based on JEDEC standard JESD51-5.)

## ■ TYPICAL CHARACTERISTICS ( $V_O = 3.3 \text{ V}$ )

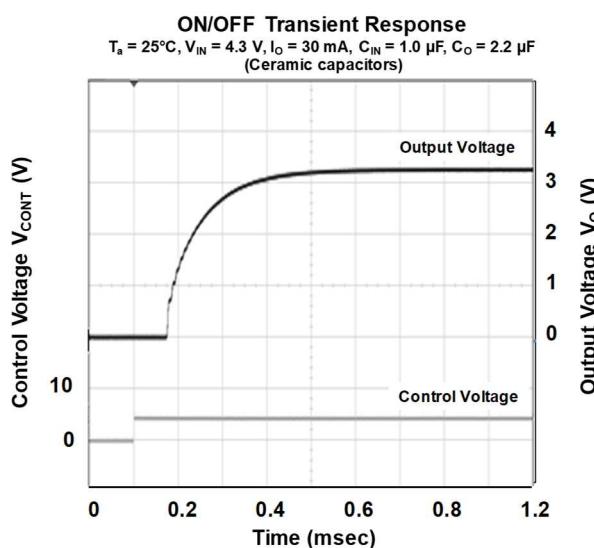
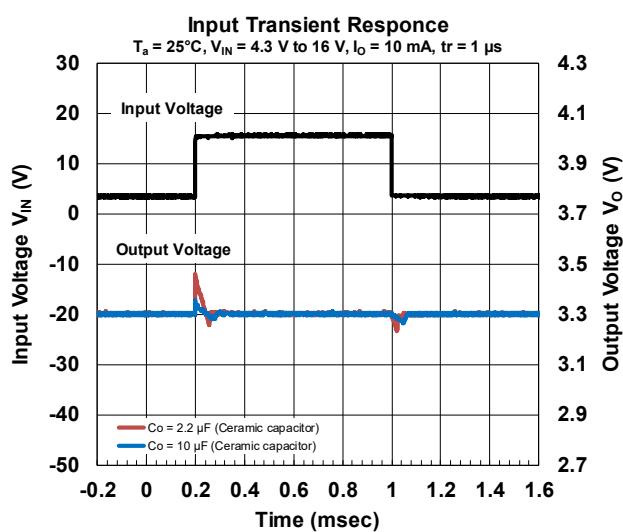
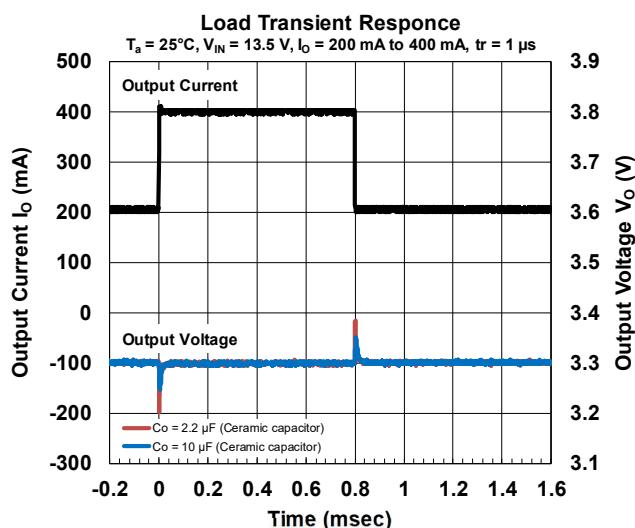
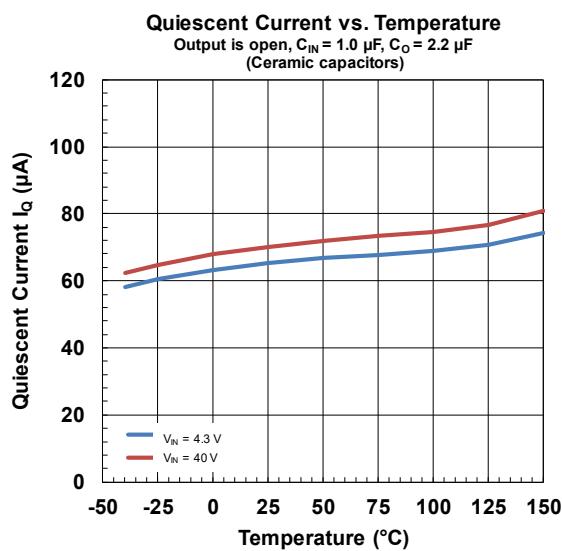


## ■ TYPICAL CHARACTERISTICS ( $V_O = 3.3 V$ )

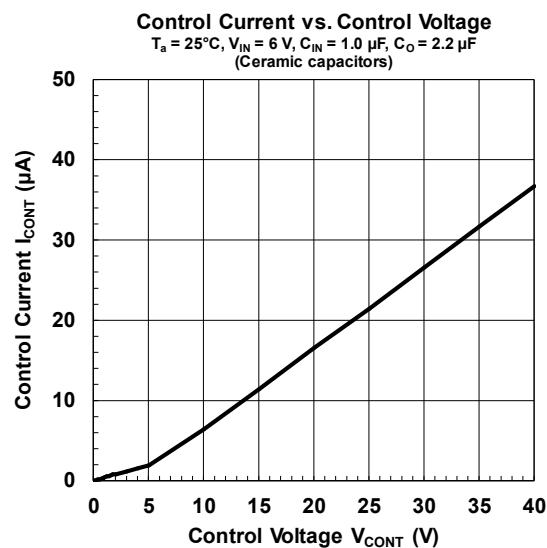
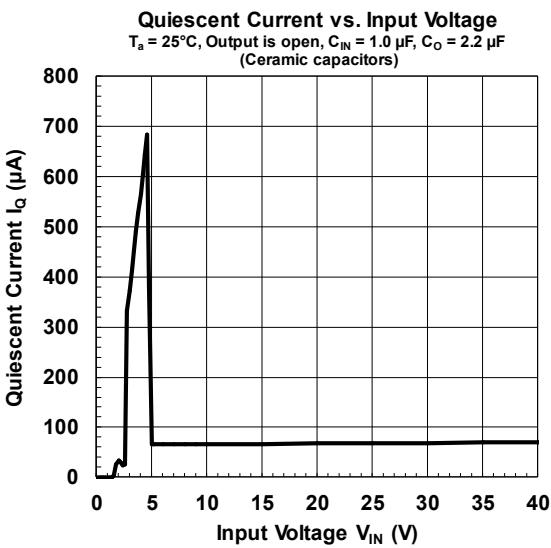
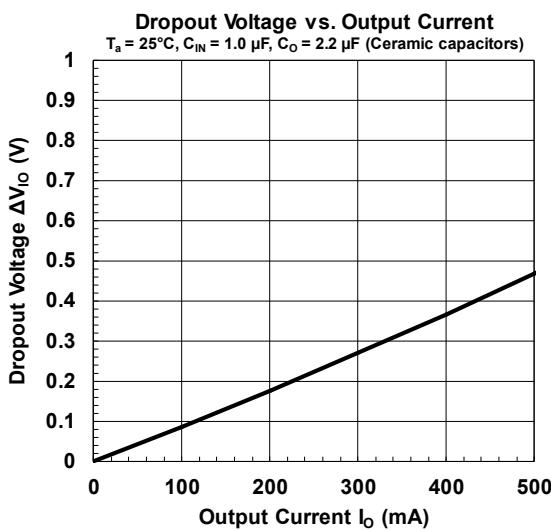
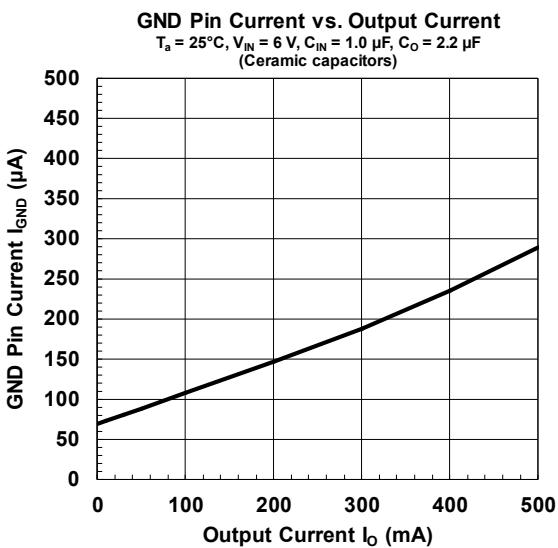
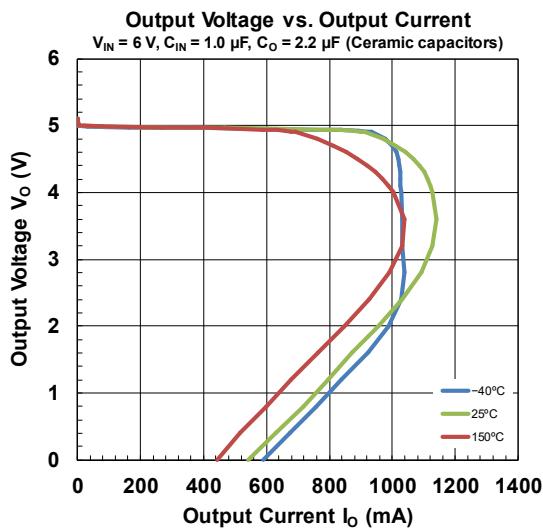
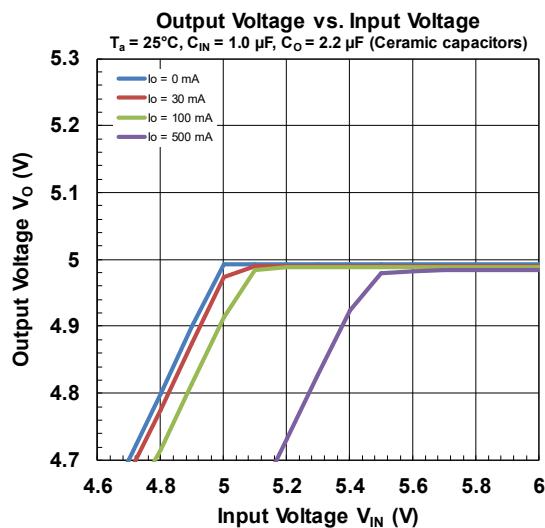


■ TYPICAL CHARACTERISTICS ( $V_O = 3.3$  V)

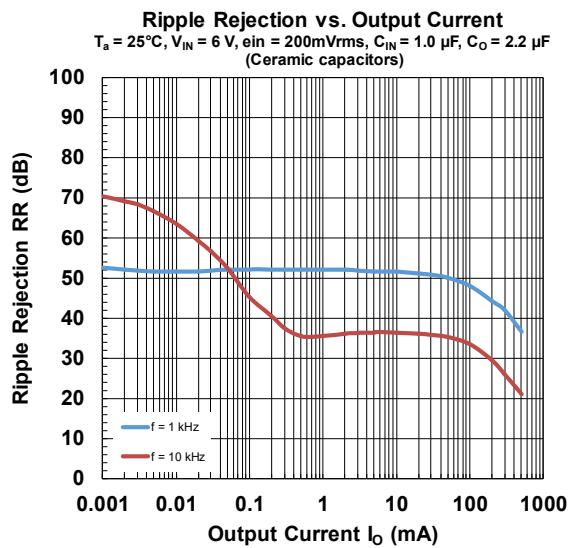
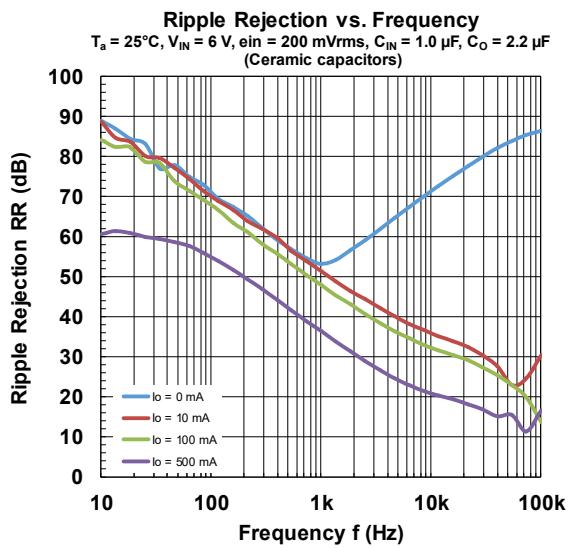
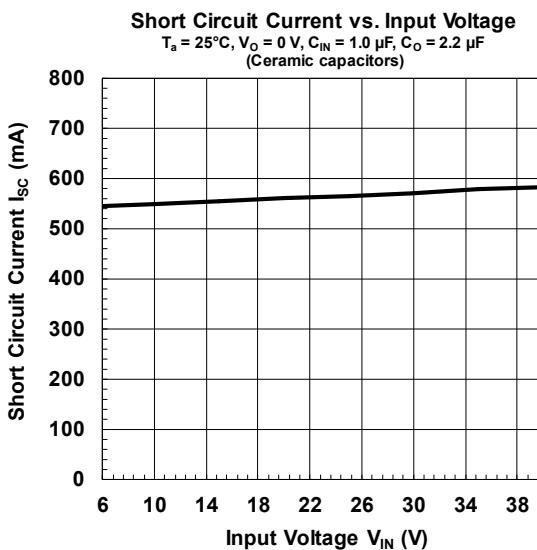
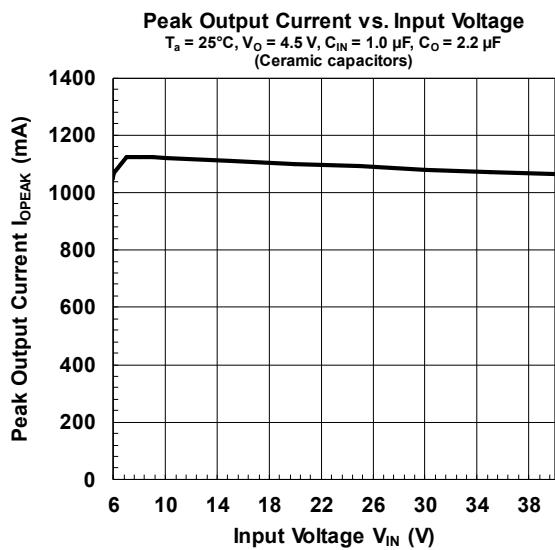
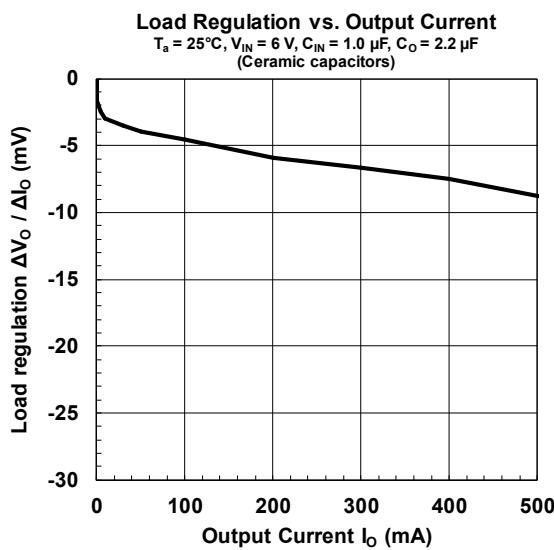
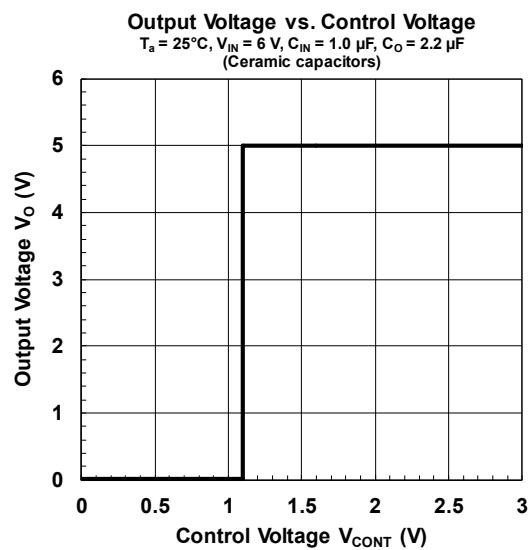
## ■ TYPICAL CHARACTERISTICS ( $V_O = 3.3$ V)



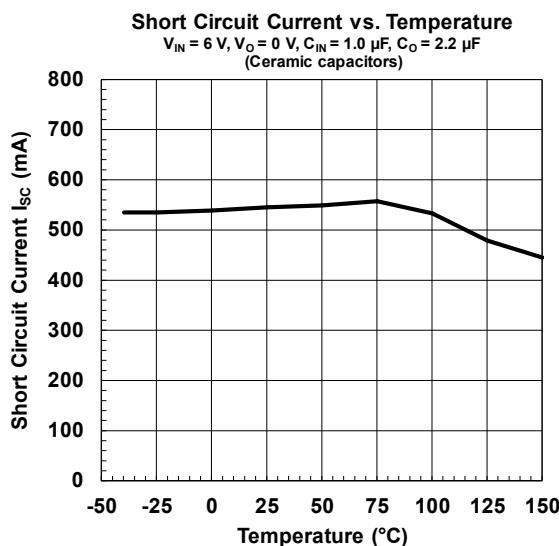
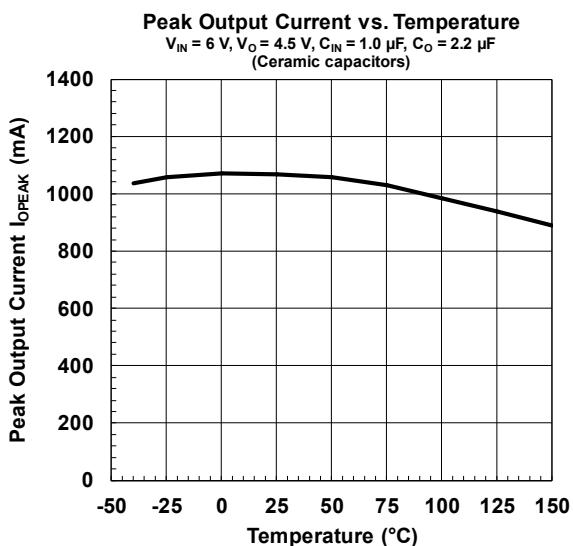
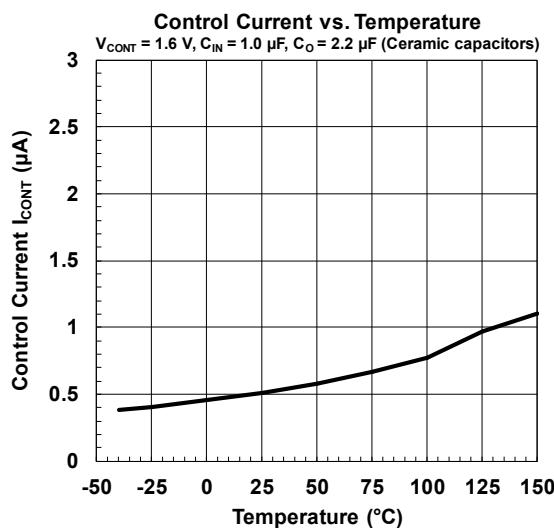
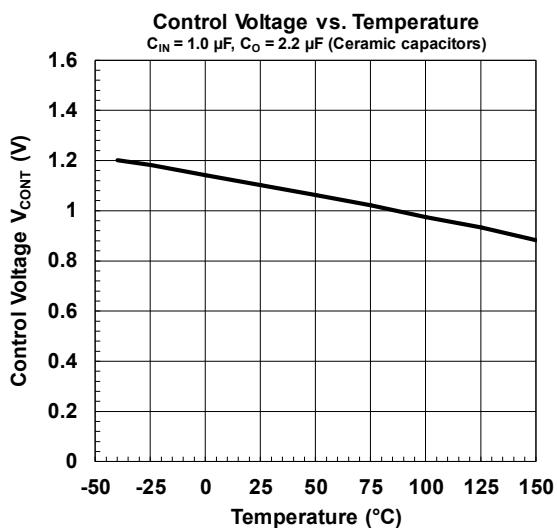
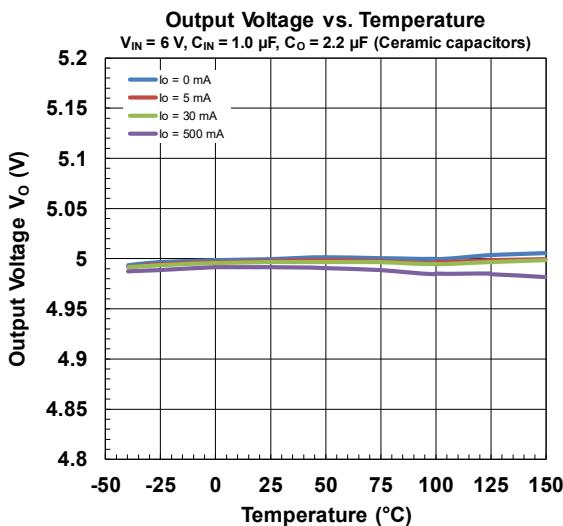
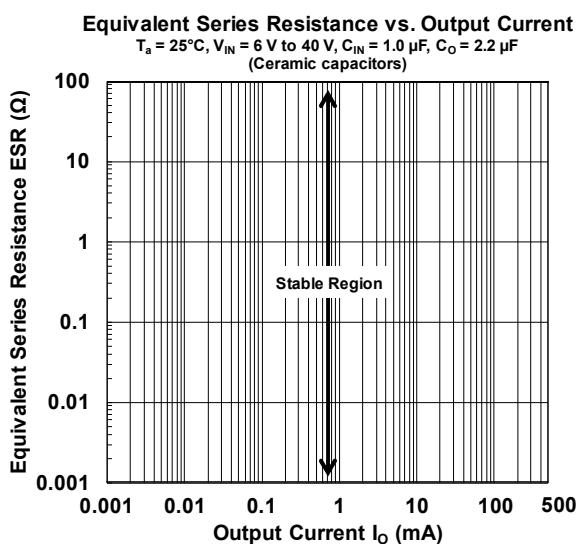
## ■ TYPICAL CHARACTERISTICS ( $V_O = 5 V$ )



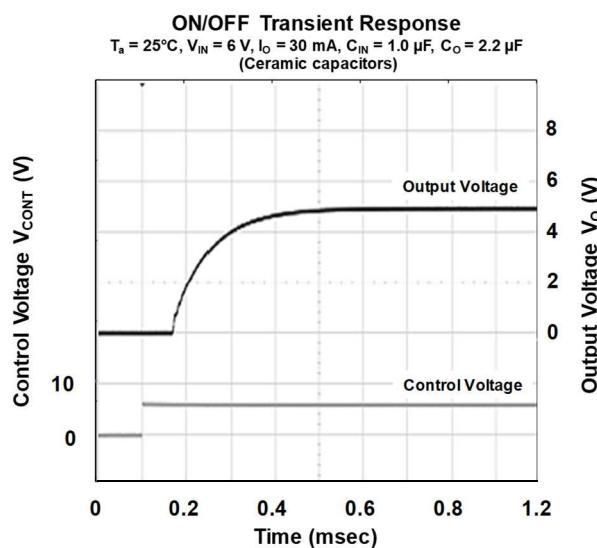
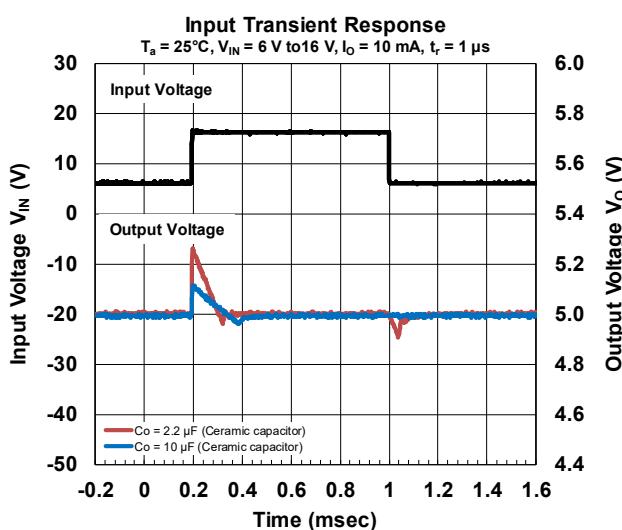
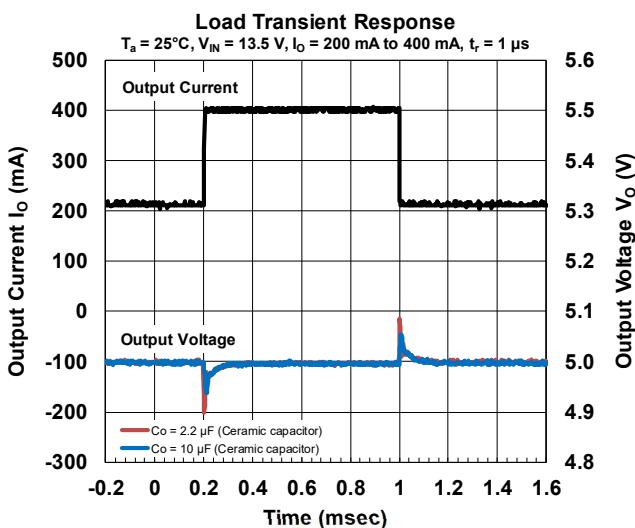
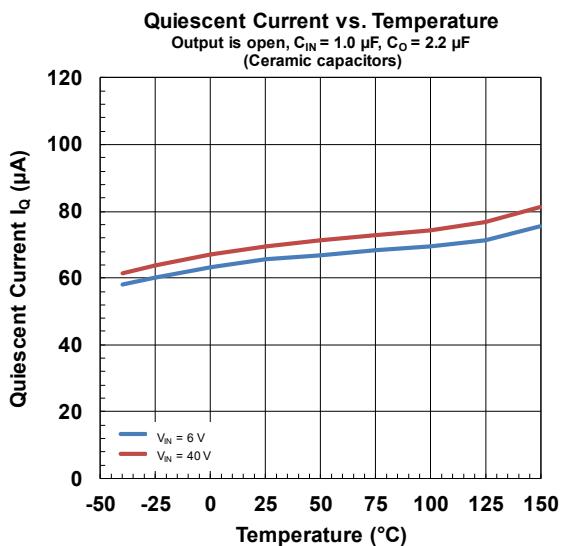
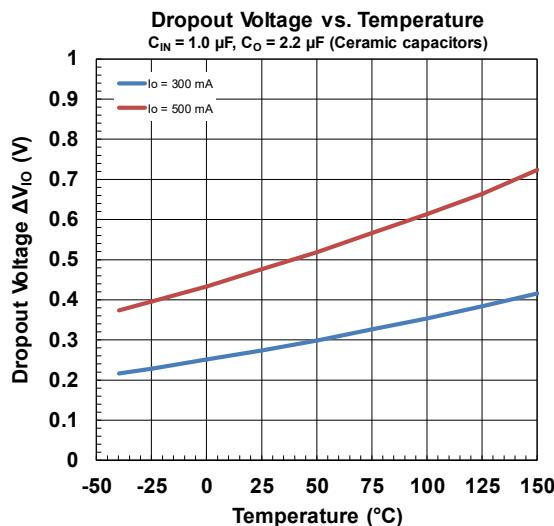
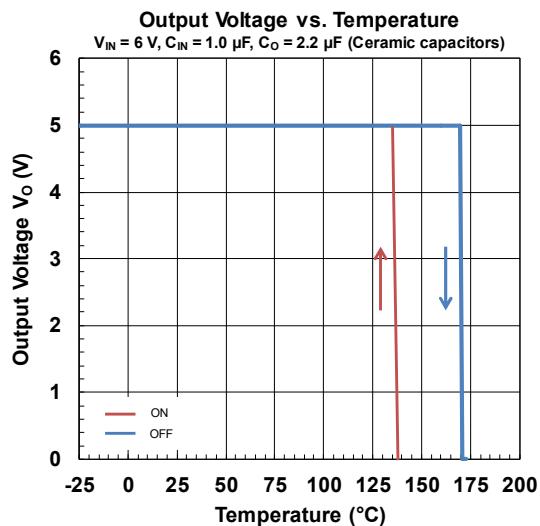
## ■ TYPICAL CHARACTERISTICS ( $V_O = 5$ V)



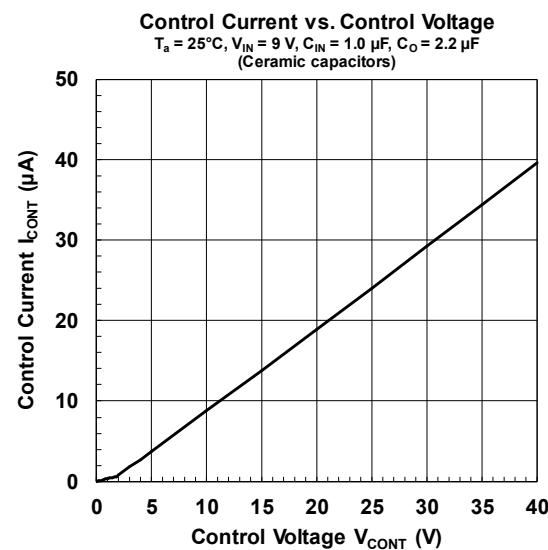
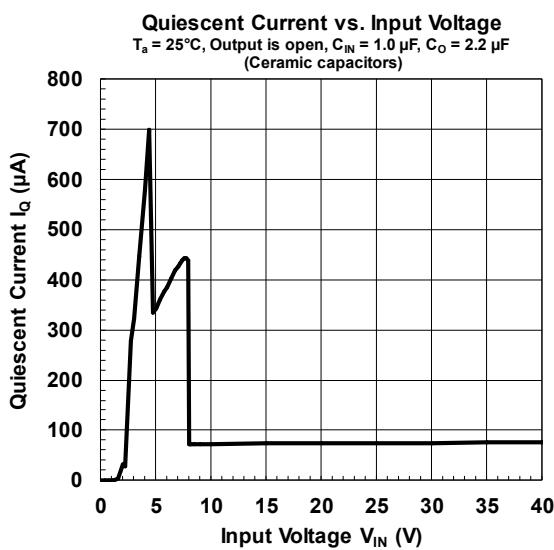
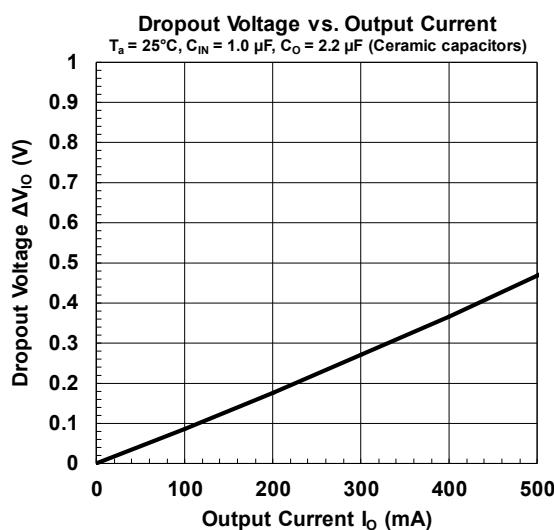
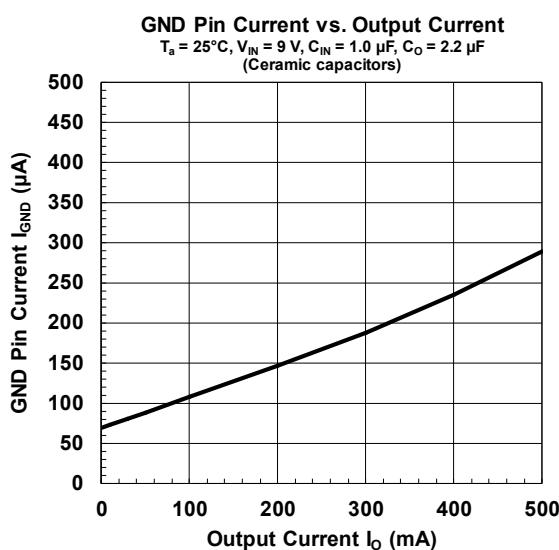
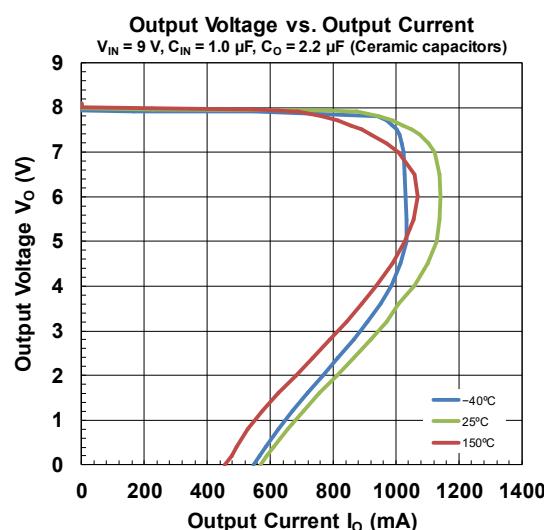
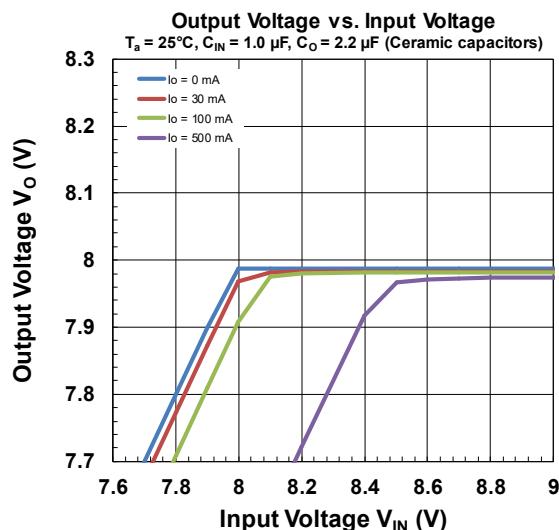
## ■ TYPICAL CHARACTERISTICS ( $V_O = 5$ V)



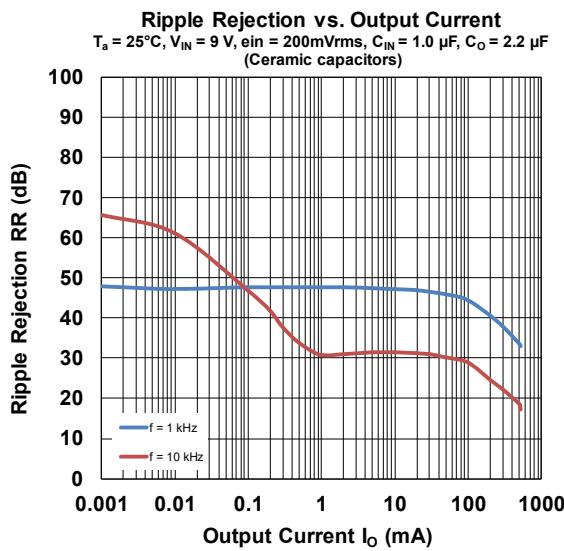
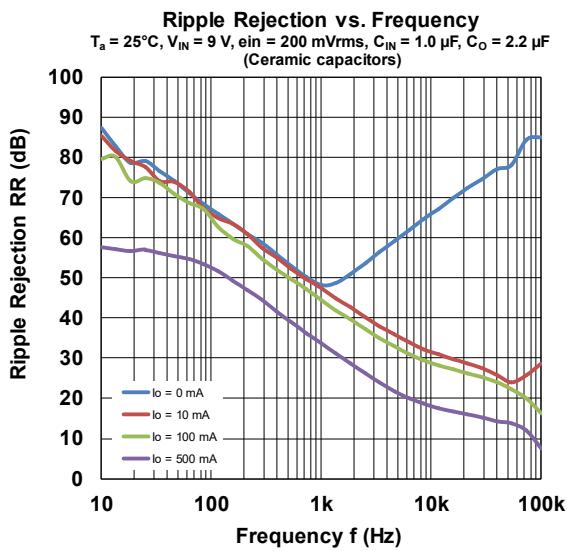
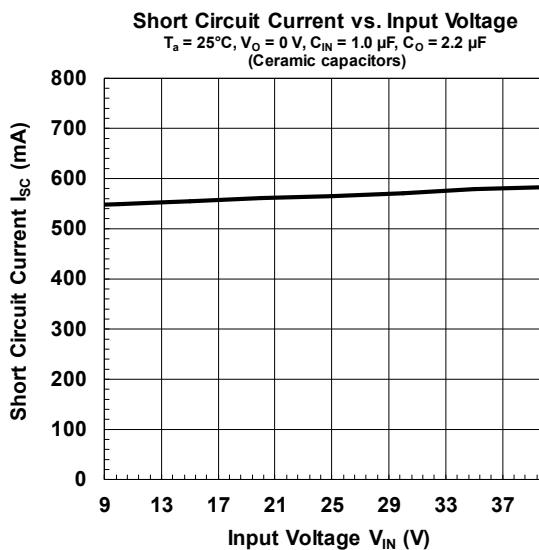
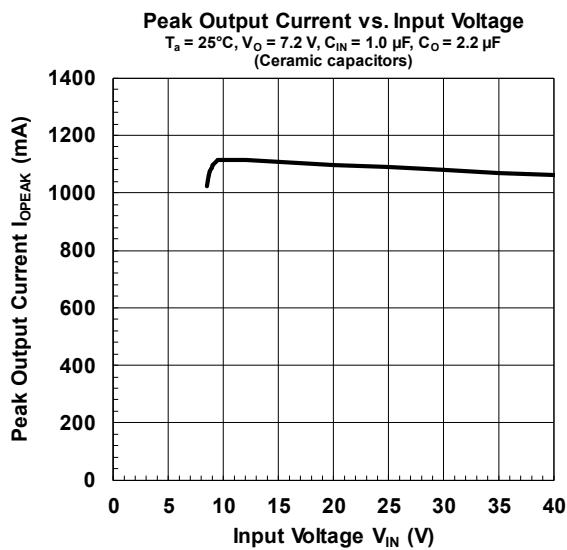
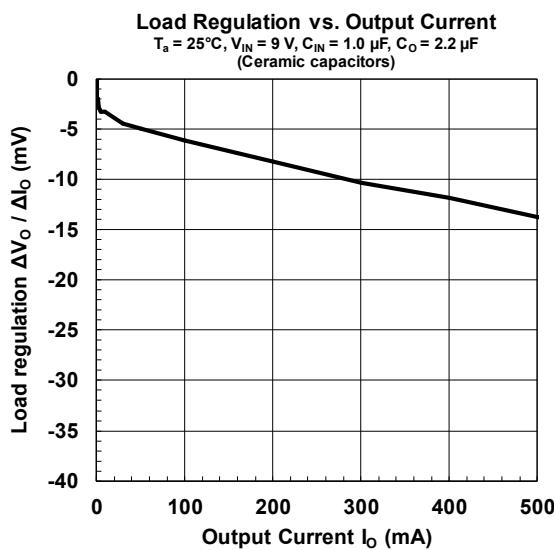
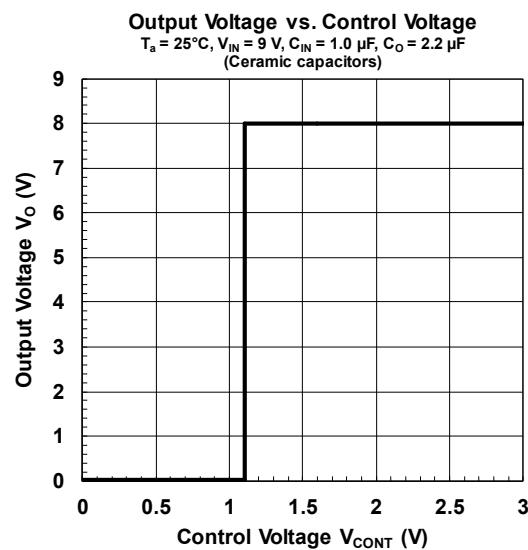
## ■ TYPICAL CHARACTERISTICS ( $V_O = 5 V$ )



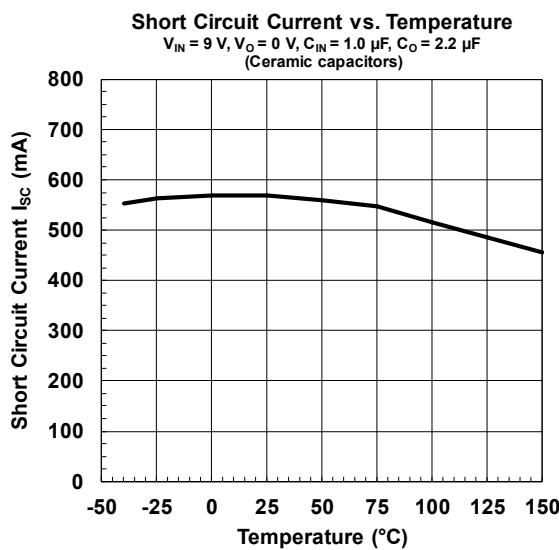
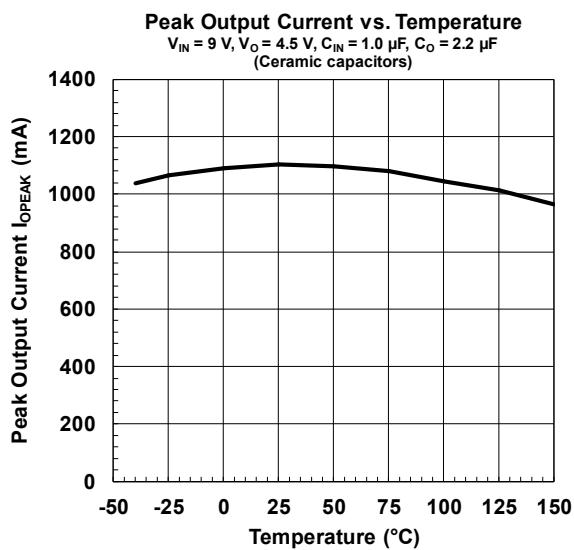
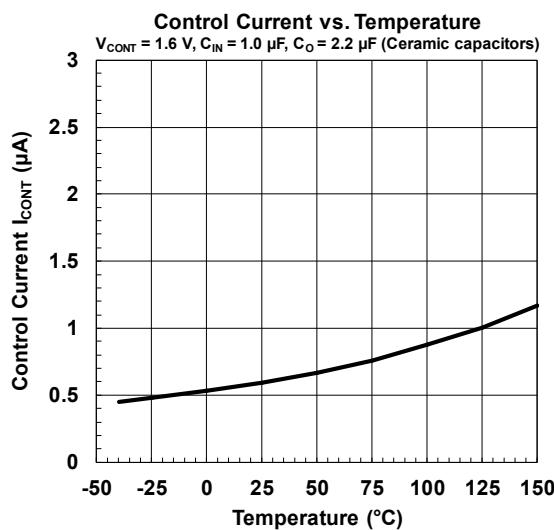
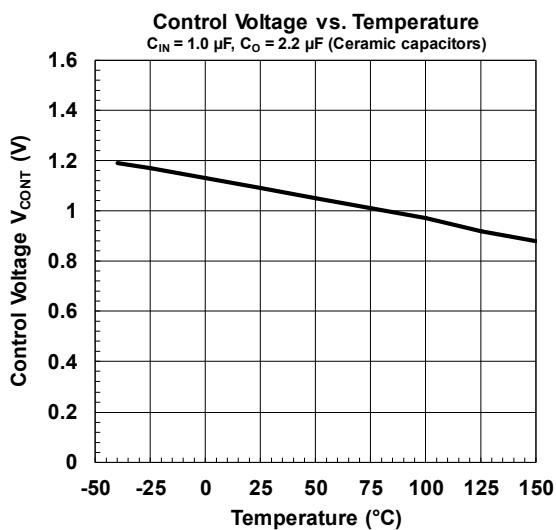
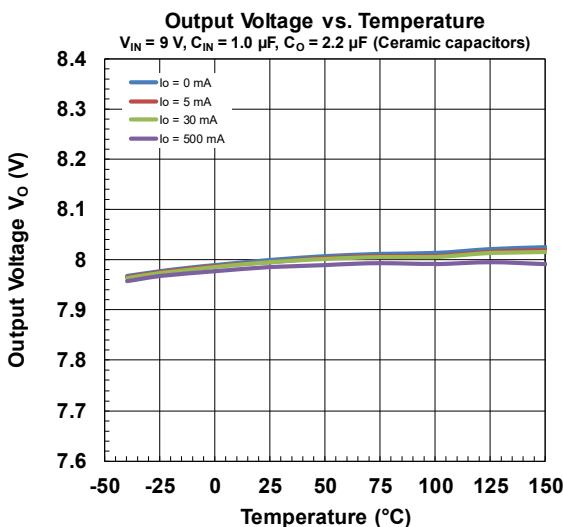
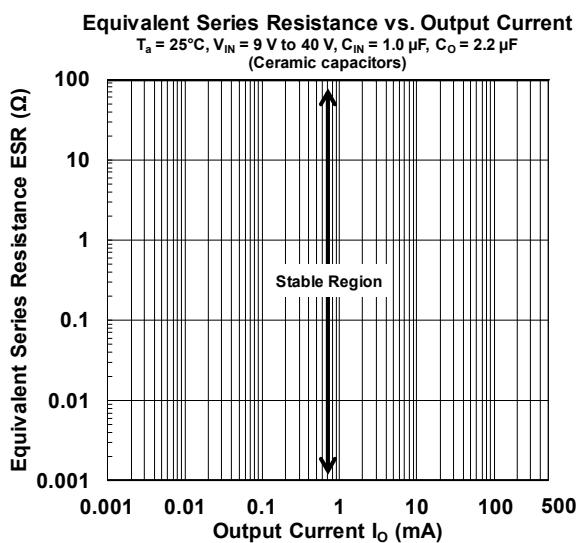
## ■ TYPICAL CHARACTERISTICS ( $V_O = 8 V$ )



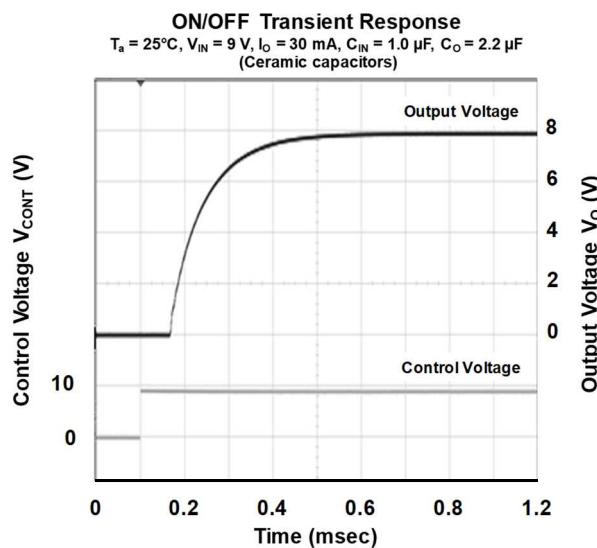
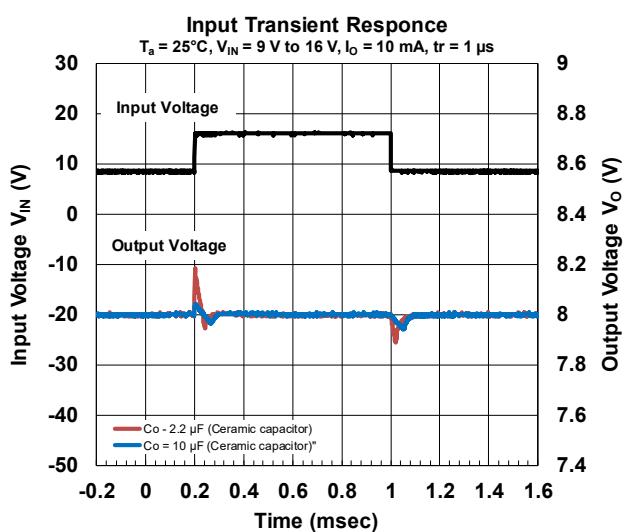
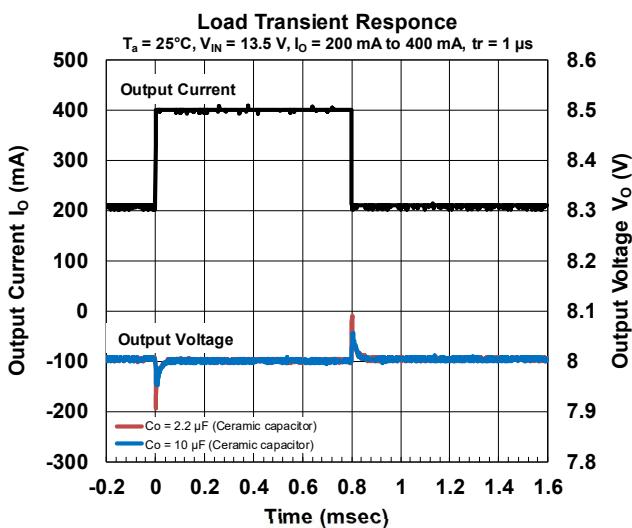
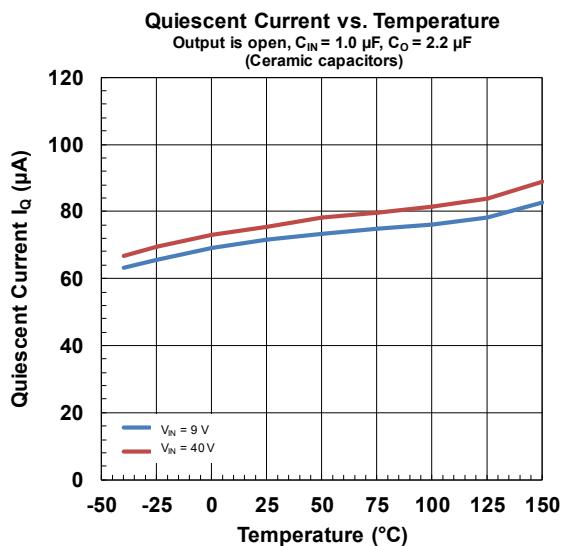
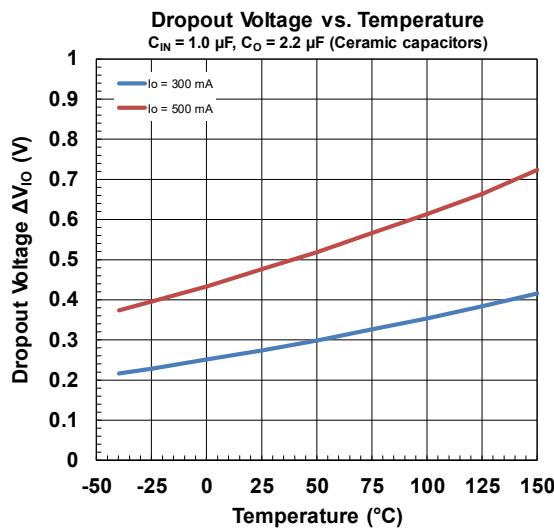
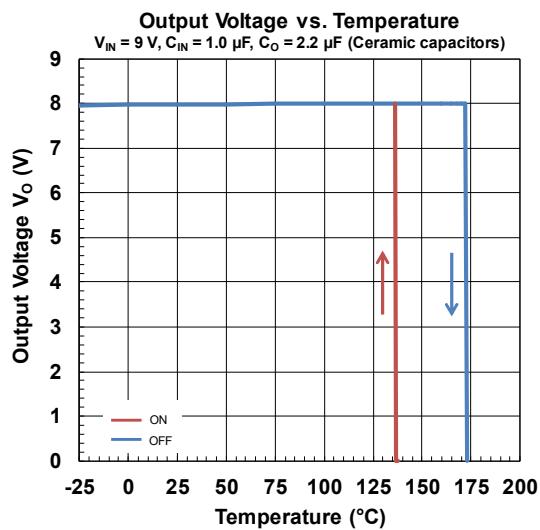
## ■ TYPICAL CHARACTERISTICS ( $V_O = 8 V$ )



## ■ TYPICAL CHARACTERISTICS ( $V_O = 8 V$ )

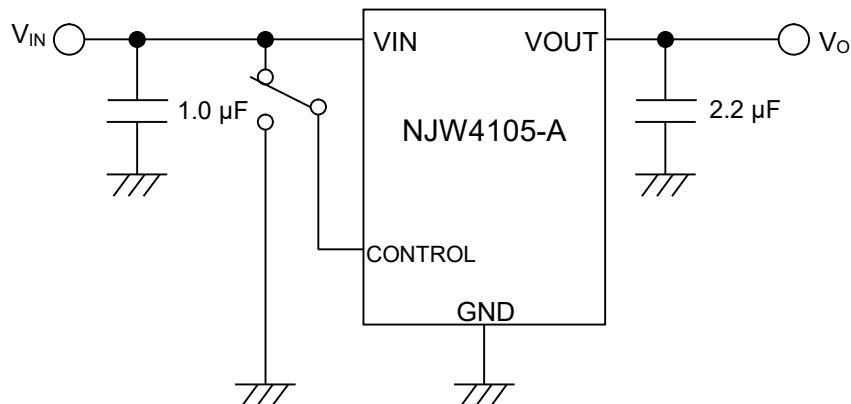


## ■ TYPICAL CHARACTERISTICS ( $V_O = 8 V$ )



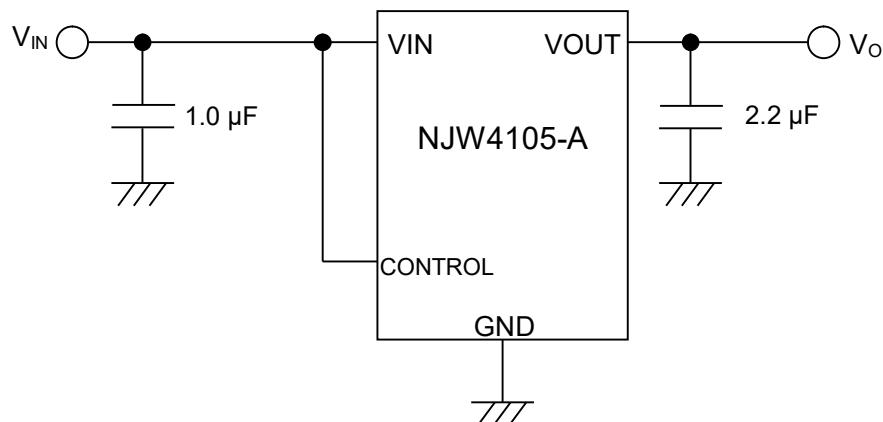
**■ TYPICAL APPLICATION**

1. When ON/OFF control is used.



The CONTROL pin is turned on at high level and turned off at open or GND level.

2. When ON/OFF control is not used.



Connect the CONTROL pin to the  $V_{IN}$ .

**■ APPLICATION NOTE****Input Capacitor ( $C_{IN}$ )**

The  $C_{IN}$  prevents oscillations and reduce power supply ripple of applications when the power supply impedance is high or power supply line is long. Connecting a 1.0  $\mu\text{F}$  or larger  $C_{IN}$  between VIN and GND pins as short path as possible.

**Output Capacitor ( $C_O$ )**

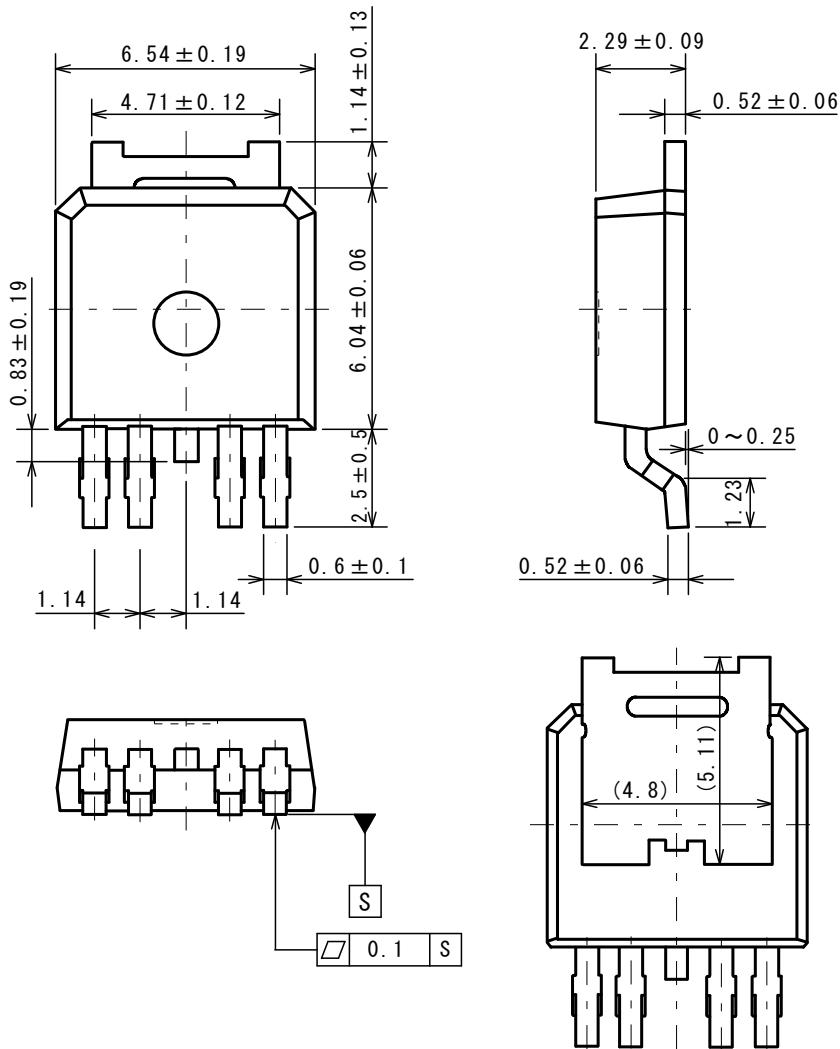
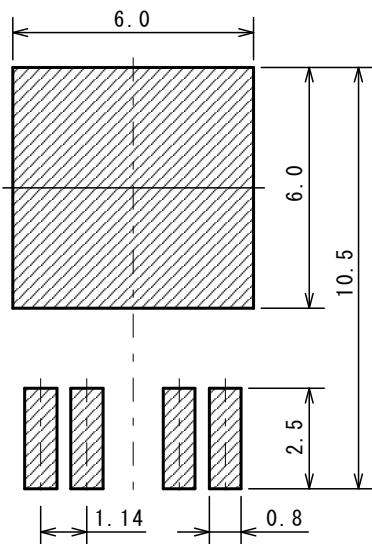
$C_O$  is necessary for phase compensation of the internal error amplifier in the regulator, and the capacitance value and ESR affect the stability of the circuit. If a capacitor less than 2.2  $\mu\text{F}$  is used, output noise and/or regulator oscillation may occur due to lack of the phase compensation. For stable operation, connect a 2.2  $\mu\text{F}$  or larger  $C_O$  within the stable operation region ( $0.001 \Omega \leq \text{ESR} \leq 100 \Omega$ ) between the VOUT and GND pins as short path as possible. The recommended capacitance value varies depending on the output voltage, and a low output voltage may require a large capacitance value; therefore, confirm the recommended capacitance of the required output voltage. As the capacitance value of  $C_O$  increases, output noise and ripple decrease, and the response to output load fluctuations also improves.

Select the output capacitor considering various characteristics such as frequency characteristics, temperature characteristics, and DC bias characteristics. For the  $C_O$ , a capacitor with excellent temperature characteristics and sufficient margin for output voltage is recommended.

**Undervoltage Lockout (UVLO)**

This circuit prevents malfunction by locking out the output when  $V_{IN}$  is below the UVLO detection voltage. The output voltage rises when the input voltage rises and exceeds the UVLO release voltage (2.7 V, typ). When the input voltage drops below the UVLO detection voltage (2.2 V, typ)\*, the output voltage falls.

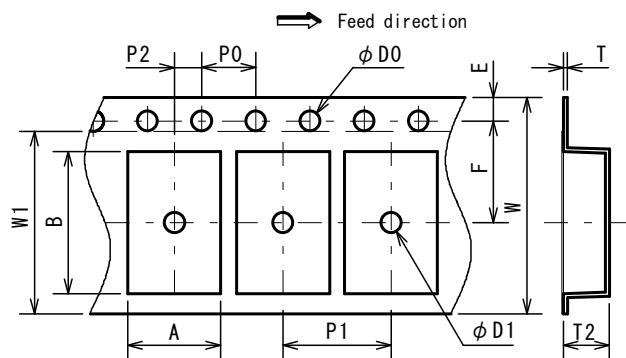
\*UVLO detection voltage (2.2 V, typ) = UVLO release voltage (2.7 V, typ) - UVLO hysteresis voltage (500 mV, typ)

**■ PACKAGE DIMENSIONS****■ EXAMPLE OF SOLDER PADS DIMENSIONS**

## ■ PACKING SPEC

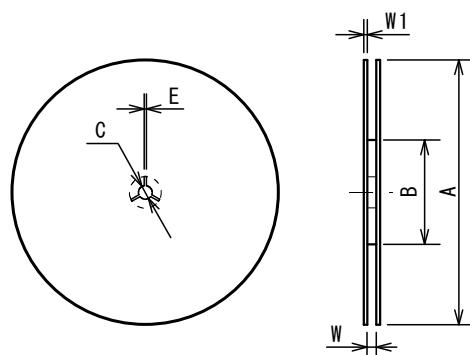
Unit: mm

## TAPING DIMENSIONS



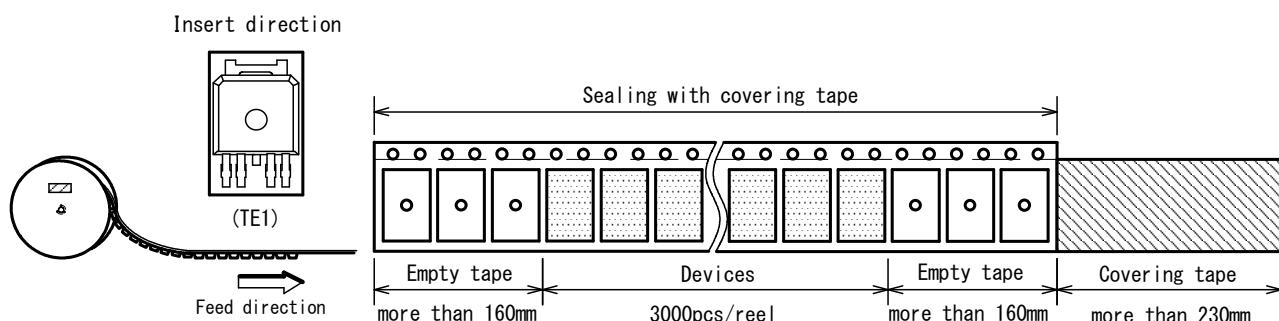
SYMBOL	DIMENSION	REMARKS
A	$6.9 \pm 0.1$	BOTTOM DIMENSION
B	$10.5 \pm 0.1$	BOTTOM DIMENSION
D0	$1.5^{+0.1}_0$	
D1	$1.5^{+0.1}_0$	
E	$1.75 \pm 0.1$	
F	$7.5 \pm 0.1$	
P0	$4.0 \pm 0.1$	
P1	$8.0 \pm 0.1$	
P2	$2.0 \pm 0.1$	
T	$0.3 \pm 0.1$	
T2	3.4 max	
W	$16.0 \pm 0.3$	
W1	13.5	THICKNESS 0.1max

## REEL DIMENSIONS

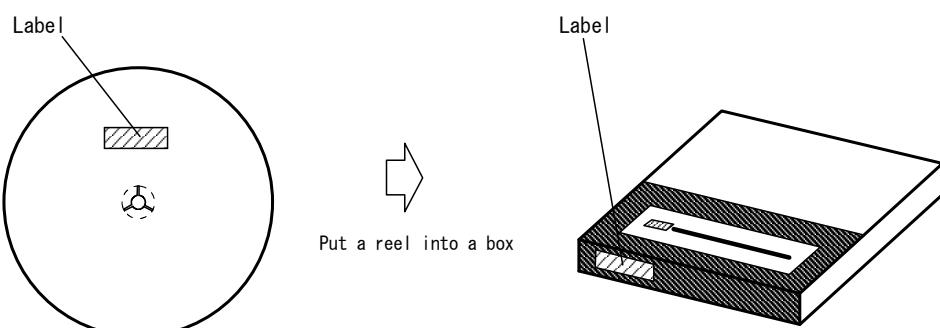


SYMBOL	DIMENSION
A	$\phi 330 \pm 2$
B	$\phi 80 \pm 1$
C	$\phi 13 \pm 0.5$
E	2
W	$17.5 \pm 0.5$
W1	2 ± 0.5

## TAPING STATE

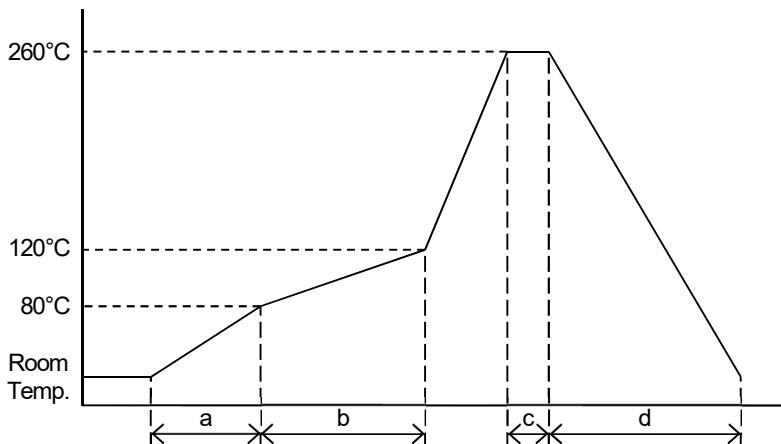


## PACKING STATE



## ■ RECOMMENDED MOUNTING METHOD

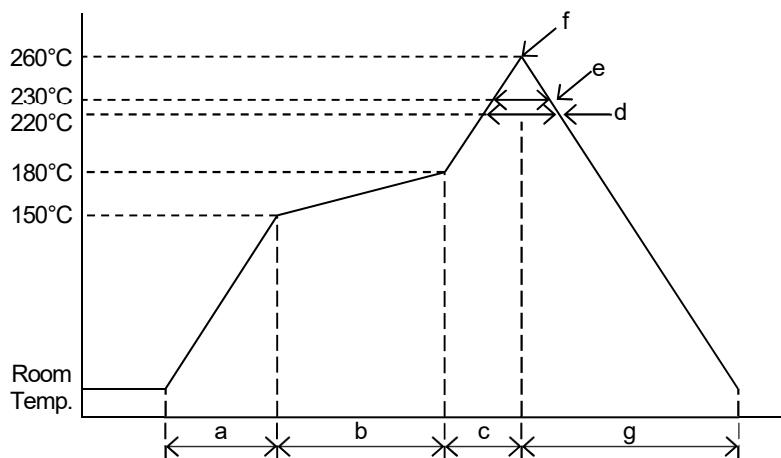
### FLOW SOLDERING PROFILE



a	Temperature ramping rate	1 to 7°C/s
b	Pre-heating temperature Pre-heating time	80 to 120°C 60 to 120s
c	Peak temperature Peak time	lower than 260°C shorter than 10s
d	Temperature ramping rate	1 to 7°C/s

The temperature indicates at the surface of mold package.

### INFRARED REFLOW SOLDERING PROFILE



a	Temperature ramping rate	1 to 4°C/s
b	Pre-heating temperature Pre-heating time	150 to 180°C 60 to 120s
c	Temperature ramping rate	1 to 4°C/s
d	220°C or higher time	shorter than 60s
e	230°C or higher time	shorter than 40s
f	Peak temperature	lower than 260°C
g	Temperature ramping rate	1 to 6°C/s

The temperature indicates at the surface of mold package.

## ■ REVISION HISTORY

DATE	REVISION	CHANGES
June 9, 2021	Ver.1.0	New Release

**[ CAUTION ]**

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The introduction of external contaminants (e.g. dust, oil or cosmetics) can result in failures of semiconductor products.
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5. Special care is required in designing devices, machinery or equipment which demand high levels of reliability. This is particularly important when designing critical components or systems whose failure can foreseeably result in situations that could adversely affect health or safety. In designing such critical devices, equipment or machinery, careful consideration should be given to amongst other things, their safety design, fail-safe design, back-up and redundancy systems, and diffusion design.
6. The products listed in this datasheet may not be appropriate for use in certain equipment where reliability is critical or where the products may be subjected to extreme conditions. You should consult our sales office before using the products in any of the following types of equipment.
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  - Equipment Used in the Deep Sea
  - Power Generator Control Equipment (Nuclear, steam, hydraulic, etc.)
  - Life Maintenance Medical Equipment
  - Fire Alarms / Intruder Detectors
  - Vehicle Control Equipment (Airplane, railroad, ship, etc.)
  - Various Safety Devices
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8. Warning for handling Gallium and Arsenic (GaAs) Products (Applying to GaAs MMIC, Photo Reflector). These products use Gallium (Ga) and Arsenic (As) which are specified as poisonous chemicals by law. For the prevention of a hazard, do not burn, destroy, or process chemically to make them as gas or power. When the product is disposed of, please follow the related regulation and do not mix this with general industrial waste or household waste.
9. The product specifications and descriptions listed in this datasheet are subject to change at any time, without notice.

